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Bib Data Sheet

CONFIRMATION NO. 4751

<b>SERIAL NUMBER</b> 09/991,142	<b>FILING DATE</b> 11/16/2001 <b>RULE</b>	<b>CLASS</b> 257	<b>GROUP ART UNIT</b> 2811	<b>ATTORNEY DOCKET NO.</b> BUR920000140US1
<b>APPLICANTS</b> James S. Dunn, Jericho, VT; Louis D. Lanzerotti, Burlington, VT; Steven H. Voldman, Burlington, VT;				
<b>** CONTINUING DATA *****</b> <i>N/A</i> <i>Egle</i> <i>9/3/04</i>				
<b>** FOREIGN APPLICATIONS *****</b> <i>N/A</i> <i>9/3/07</i>				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 01/17/2002</b>				
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Allowance <i>[Signature]</i> Verified and Acknowledged <i>[Signature]</i> Examiner's Signature Initials		<b>STATE OR COUNTRY</b> VT	<b>SHEETS DRAWING</b> 22	<b>TOTAL CLAIMS</b> 19
<b>INDEPENDENT CLAIMS</b> 4				
<b>ADDRESS</b> Connolly Bove Lodge & Hutz LLP P.O. Box 19088 Washington, DC 20036-3425				
<b>TITLE</b> Semiconductor device and method having multiple subcollectors formed on a common wafer				
<b>FILING FEE RECEIVED</b> 824	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	